L	Hits	Search Text	DB	Time stamp
Number 1	1	("5895264").PN.	USPAT;	2003/10/20
	-	'	US-PGPUB	11:10
2	0	korean with patent with "941273"	JPO;	2003/10/20
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3	U	korean with patent with "94-1273"	JPO; DERWENT	2003/10/20 11:12
4	0	"1994" and hyundai and (kim adj jae adj	JPO;	2003/10/20
		gap)	DERWENT	11:14
5	0	"1994" and hyundai and (kim with jae with	JPO;	2003/10/20
6	0	gap) "1994" and (hyundai adj electronics) and	DERWENT JPO;	11:14
	·	(kim with jae with gap)	DERWENT	11:15
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8	0	gap) "1994" and (hyundai adj electronics) and	US-PGPUB USPAT	11:15
	U	(kim with jae with gap)	USPAT	2003/10/20 11:15
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		jae with gap)		11:15
10	0	(hyundai adj electronics) and (kim with jae with gap)	US-PGPUB	2003/10/20
11	2748	438/637,640,672,675.ccls.	USPAT;	2003/10/20
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12	1649	438/637,640,672,675.ccls. and	USPAT;	2003/10/20
13	5045	@ad<19990916 438/618,253,586,595,639,672.ccls.	US-PGPUB USPAT;	11:48
] 13	3043	430,010,233,300,333,033,012.0013.	US-PGPUB	11:48
14	3072	438/618,253,586,595,639,672.ccls. and	USPAT;	2003/10/20
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22	80	(((samsung or (kim with in with sung) or	EPO; JPO;	2003/10/20
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3 of 3